Amendments to the Claims

- 1. (Cancelled)
- (Previously presented) The apparatus of claim 25, further comprising a backside heating device to emit heat towards a second side of the target area.
- 3. (Original) The apparatus of claim 2, wherein the backside heating device comprises at least one of a group consisting of a hotplate, a tungsten lamp, and a halogen lamp.
- 4. (Original) The apparatus of claim 3, wherein the backside heating device further comprises a plurality of heating zones, each heating zone capable of being independently controlled.
- 5. (Previously presented) The apparatus of claim 25, wherein the reflecting device is a plate-type reflector.
- 6. (Currently amended) The apparatus of claim 5, further comprising:
 a vertical axis substantially through the center of the apparatus; and
 the plurality of first and second reflecting zones being substantially symmetrical
 around the vertical axis.
- 7. (Currently amended) The apparatus of claim 6, wherein the plurality of first and second reflecting zones are concentric rings.
- 8. (Currently amended) The apparatus of claim 25, wherein each of the plurality of <u>first and the second</u> reflecting zones comprises at least one of a group consisting of aluminum, gold, stainless steel, and molybdenum.
- 9. (Previously presented) The apparatus of claim 25, wherein the flash lamp comprises a plasma-type flash lamp.
- 10. (Original) The apparatus of claim 9, wherein the plasma-type flash lamp comprises a Xenon lamp or a Mercury lamp.
- 11. (Previously presented) The apparatus of claim 25, wherein the target area is adapted to receive a substrate.
- 12. (Original) The apparatus of claim 11, wherein the substrate comprises a 300-mm semiconductor wafer.
- 13. (Cancelled)

- 14. (Previously presented) The method for flash lamp processing of claim 26, wherein the reflecting device is a plate-type reflector that is substantially axis-symmetric around a vertical axis.
- 15. (Previously presented) The method for flash lamp processing of claim 26, further comprising:

heating a second surface of the substrate with a backside heating device to a pre-flash temperature prior to generating radiation from the flash lamp.

16. (Currently amended) The method for flash lamp processing of claim 15, wherein the backside heating device comprises a plurality of heating zones, and the method further includes

independently controlling the <u>plurality of</u> heating zones based at least in part on reflectivity of portions of the substrate.

17. (Previously presented) The method for flash lamp processing of claim 15, further comprising:

activating implanted ions in the first surface of the substrate by heating the second surface to a pre-flash temperature approximately at or below an ion diffusion temperature; and

heating the first surface of substrate to a temperature approximately between the ion diffusion temperature and a substrate melting temperature, said heating the first surface done, at least in part, by radiation generated from the flash lamp.

- 18. (Previously presented) The method for flash lamp processing of claim 17, wherein the radiation generated from the flash lamp heat the first surface of the substrate to a temperature just below the substrate melting temperature.
- 19. (Original) The method for flash lamp processing of claim 17, wherein the first surface of the substrate is above the ion diffusion temperature for a time period of approximately three milliseconds or less.
- 20. (Cancelled)
- 21. (Previously presented) The system of claim 27, wherein the substrate comprises a semiconductor wafer.
- 22. (Previously presented) The system of claim 27, wherein the pre-flash processing device comprises one of a group consisting of an ion implantation device, a metal deposition device, a low-k deposition device, and a high-k deposition device.
- 23. (Previously presented) The system of claim 27, wherein the flash lamp reactor further comprises:
 - a backside heating device, to emit heat towards a second side of the target area.

- (Original) The system of claim 23, wherein the backside heating device includes 24. a plurality of heating zones, each heating zone capable of being independently controlled.
- 25. (Currently amended) An apparatus comprising: a target area:
- a reflecting device having a first reflective-reflecting zone with a first reflectivity and a second reflecting zone with a second reflectivity that is different from the first reflectivity: and
- a flash lamp, disposed between the reflecting device and the target area, to provide radiation to be reflected off the reflecting device substantially towards a first side of the target area.
- 26. A method for flash lamp processing comprising: (Currently amended) generating radiation from a flash lamp disposed between a reflecting device and a target area; and

reflecting a first portion of the radiation with a first reflecting zone of the reflecting device toward the target area, the first reflecting zone having a first reflectivity; and

reflecting a second portion of the radiation with a second reflecting zone of the reflecting device toward the target area, the second reflecting zone having a second reflectivity that is different from the first reflectivity.

- 27. (Previously presented) A system comprising: a pre-flash processing device adapted to process a substrate; a flash lamp reactor including
 - a target area adapted to receive the substrate such that the first surface of the substrate corresponds with a first side of the target area;
 - a reflecting device having a first reflecting zone with a first reflectivity and a second reflecting zone with a second reflectivity that is different from the first reflectivity; and
 - a flash lamp, disposed between the reflecting device and the target area, to provide radiation to be reflected off the reflecting device substantially towards the first side of the target area; and
- a transfer mechanism adapted to transfer the substrate from the pre-flash processing device to the flash lamp reactor.
- (New) The apparatus of claim 25, wherein the first reflecting zone is configured to reflect radiation received from the flash lamp substantially towards a first area of the first side and the second reflecting zone is configured to reflect radiation received from the flash lamp substantially towards a second area of the first side, which is different than the first area.
- 29. (New) The apparatus of claim 25, wherein the first reflecting zone is configured to receive radiation provided from the flash lamp in a first direction and the second

reflecting zone is configured to receive radiation provided from the flash lamp in a second direction, which is different from the first direction.